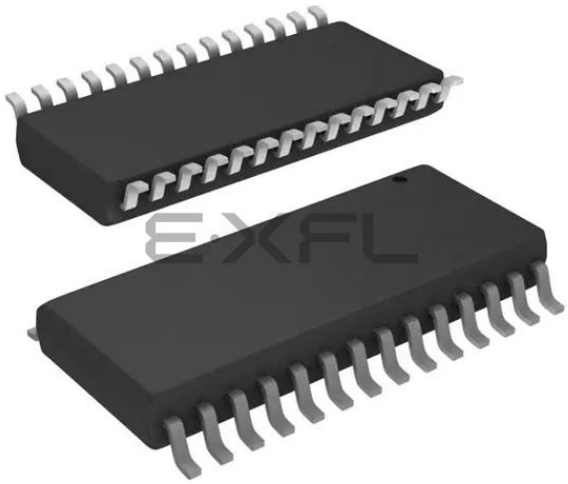

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Details	
Product Status	Active
Core Processor	MIPS32® microAptiv™
Core Size	32-Bit Single-Core
Speed	25MHz
Connectivity	IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, HLVD, I²S, POR, PWM, WDT
Number of I/O	22
Program Memory Size	16KB (16K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 3.6V
Data Converters	A/D 12x10/12b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	28-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic32mm0016gpl028-e-so

TABLE 3-2: COPROCESSOR 0 REGISTERS

Register Number	Register Name	Function
0-3	Reserved	Reserved in the microAptiv™ UC.
4	UserLocal	User information that can be written by privileged software and read via RDHWR, Register 29.
5-6	Reserved	Reserved in the microAptiv UC.
7	HWREna	Enables access via the RDHWR instruction to selected hardware registers in Non-Privileged mode.
8	BadVAddr(1)	Reports the address for the most recent address related exception.
9	Count(1)	Processor cycle count.
10	Reserved	Reserved in the microAptiv UC.
11	Compare(1)	Timer interrupt control.
12	Status/ IntCtl/ SRSCtl/ SRSMap1/ View_IPL/ SRSMAP2	Processor status and control; interrupt control and shadow set control.
13	Cause(1)/ View_RIPL	Cause of last exception.
14	EPC(1)	Program Counter at last exception.
15	PRId/ EBase/ CDMMBase	Processor identification and revision; exception base address; Common Device Memory Map Base register.
16	CONFIG/ CONFIG1/ CONFIG2/ CONFIG3/ CONFIG7	Configuration registers.
7-22	Reserved	Reserved in the microAptiv UC.
23	Debug/ Debug2/ TraceControl/ TraceControl2/ UserTraceData1/ TraceBPC(2)	EJTAG Debug register. EJTAG Debug Register 2. EJTAG Trace Control register. EJTAG Trace Control Register 2. EJTAG User Trace Data 1 register. EJTAG Trace Breakpoint register.
24	DEPC(2)/ UserTraceData2	Program Counter at last debug exception. EJTAG User Trace Data 2 register.
25	PerfCtl0/ PerfCnt0/ PerfCtl1/ PerfCnt1	Performance Counter 0 control. Performance Counter 0. Performance Counter 1 control. Performance Counter 1.
26	ErrCtl	Software parity check enable.
27	CacheErr	Records information about SRAM parity errors.
28-29	Reserved	Reserved in the PIC32 core.
30	ErrorEPC(1)	Program Counter at last error.
31	DeSAVE(2)	Debug Handler Scratchpad register.

Note 1: Registers used in exception processing.

2: Registers used in debug.

7.1 CPU Exceptions

CPU Coprocessor 0 contains the logic for identifying and managing exceptions. Exceptions can be caused by a variety of sources, including boundary cases in data, external events or program errors. Table 7-1 lists the exception types in order of priority.

TABLE 7-1: MIPS32® microAptiv™ UC MICROPROCESSOR CORE EXCEPTION TYPES

Exception Type (In Order of Priority)	Description	Branches to	Status Bits Set	Debug Bits Set	EXCCODE	XC32 Function Name
Highest Priority						
Reset	Assertion of $\overline{\text{MCLR}}$.	0xBFC0_0000	BEV, ERL	—	—	_on_reset
Soft Reset	Execution of a RESET instruction.	0xBFC0_0000	BEV, SR, ERL	—	—	_on_reset
DSS	EJTAG debug single step.	0xBFC0_0480 (ProbEn = 0 in ECR) 0xBFC0_0200 (ProbEn = 1 in ECR)	—	DSS	—	—
DINT	EJTAG debug interrupt. Caused by setting the EjtagBrk bit in the ECR register.	0xBFC0_0480 (ProbEn = 0 in ECR) 0xBFC0_0200 (ProbEn = 1 in ECR)	—	DINT	—	—
NMI	Non-maskable interrupt.	0xBFC0_0000	BEV, NMI, ERL	—	—	_nmi_handler
Interrupt	Assertion of unmasked hardware or software interrupt signal.	See Table 7-2	IPL<2:0>	—	Int (0x00)	See Table 7-2
DIB	EJTAG debug hardware instruction break matched.	0xBFC0_0480 (ProbEn = 0 in ECR) 0xBFC0_0200 (ProbEn = 1 in ECR)	—	DIB	—	—
AdEL	Load address alignment error.	EBASE + 0x180	EXL	—	ADEL (0x04)	_general_exception_handler
IBE	Instruction fetch bus error.	EBASE + 0x180	EXL	—	IBE (0x06)	_general_exception_handler
DBp	EJTAG breakpoint (execution of SDBBP instruction).	0xBFC0_0480 (ProbEn = 0 in ECR) 0xBFC0_0200 (ProbEn = 1 in ECR)	DBp	—	—	—
Sys	Execution of SYSCALL instruction.	EBASE + 0x180	EXL	—	Sys (0x08)	_general_exception_handler
Bp	Execution of BREAK instruction.	EBASE + 0x180	EXL	—	Bp (0x09)	_general_exception_handler

TABLE 7-1: MIPS32® microAptiv™ UC MICROPROCESSOR CORE EXCEPTION TYPES (CONTINUED)

Exception Type (In Order of Priority)	Description	Branches to	Status Bits Set	Debug Bits Set	EXCCODE	XC32 Function Name
CpU	Execution of a coprocessor instruction for a coprocessor that is not enabled.	EBASE + 0x180	CU, EXL	—	CpU (0x0B)	_general_exception_handler
RI	Execution of a reserved instruction.	EBASE + 0x180	EXL	—	RI (0x0A)	_general_exception_handler
Ov	Execution of an arithmetic instruction that overflowed.	EBASE + 0x180	EXL	—	Ov (0x0C)	_general_exception_handler
Tr	Execution of a trap (when trap condition is true).	EBASE + 0x180	EXL	—	Tr (0x0D)	_general_exception_handler
DDBL	EJTAG data address break (address only) or EJTAG data value break on load (address and value).	0xBFC0_0480 (ProbEn = 0 in ECR) 0xBFC0_0200 (ProbEn = 1 in ECR)	—	DDBL for a load instruction or DDBS for a store instruction	—	—
DDBS	EJTAG data address break (address only) or EJTAG data value break on store (address and value).	0xBFC0_0480 (ProbEn = 0 in ECR) 0xBFC0_0200 (ProbEn = 1 in ECR)	—	DDBL for a load instruction or DDBS for a store instruction	—	—
AdES	Store address alignment error.	EBASE + 0x180	EXL	—	ADES (0x05)	_general_exception_handler
DBE	Load or store bus error.	EBASE + 0x180	EXL	—	DBE (0x07)	_general_exception_handler
CBrk	EJTAG complex breakpoint.	0xBFC0_0480 (ProbEn = 0 in ECR) 0xBFC0_0200 (ProbEn = 1 in ECR)	—	DIBImpr, DDBLImpr and/or DDBSImpr	—	—
Lowest Priority						

REGISTER 9-1: CNCONx: CHANGE NOTIFICATION CONTROL FOR PORTx REGISTER (x = A-C)

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	R/W-0	U-0	U-0	U-0	R/W-0	U-0	U-0	U-0
	ON	—	—	—	CNSTYLE	—	—	—
7:0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 **Unimplemented:** Read as '0'

bit 15 **ON:** Change Notification (CN) Control On bit
1 = CN is enabled
0 = CN is disabled

bit 14-12 **Unimplemented:** Read as '0'

bit 11 **CNSTYLE:** Change Notification Style Selection bit
1 = Edge style (detects edge transitions, CNFx bits are used for a Change Notice event)
0 = Mismatch style (detects change from last PORTx read, CNSTATx bits are used for a Change Notification event)

bit 10-0 **Unimplemented:** Read as '0'

REGISTER 10-1: T1CON: TIMER1 CONTROL REGISTER (CONTINUED)

bit 3 **Unimplemented:** Read as '0'

bit 2 **TSYNC:** Timer1 External Clock Input Synchronization Selection bit

When TCS = 1:
1 = External clock input is synchronized
0 = External clock input is not synchronized

When TCS = 0:
This bit is ignored.

bit 1 **TCS:** Timer1 Clock Source Select bit

1 = External clock is defined by the TECS<1:0> bits
0 = Internal peripheral clock

bit 0 **Unimplemented:** Read as '0'

REGISTER 13-1: SPIxCON: SPIx CONTROL REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	FRMEN	FRMSYNC	FRMPOL	MSSEN	FRMSYPW	FRMCNT<2:0>		
23:16	R/W-0	U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0
	MCLKSEL(1)	—	—	—	—	—	SPIFE	ENHBUF(1)
15:8	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	ON	—	SIDL	DISSDO(4)	MODE32	MODE16	SMP	CKE(2)
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	SSEN	CKP(3)	MSTEN	DISSDI(4)	STXISEL<1:0>		SRXISEL<1:0>	

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31 **FRMEN:** Framed SPI Support bit
- 1 = Framed SPI support is enabled ($\overline{SSx}$ pin is used as the FSYNC1 input/output)
- 0 = Framed SPI support is disabled

bit 30 **FRMSYNC:** Frame Sync Pulse Direction Control on $\overline{SSx}$ Pin bit (Framed SPI mode only)
- 1 = Frame sync pulse input (Slave mode)
- 0 = Frame sync pulse output (Master mode)

bit 29 **FRMPOL:** Frame Sync Polarity bit (Framed SPI mode only)
- 1 = Frame pulse is active-high
- 0 = Frame pulse is active-low

bit 28 **MSSEN:** Master Mode Slave Select Enable bit
- 1 = Slave select SPI support is enabled; the $\overline{SSx}$ pin is automatically driven during transmission in Master mode, polarity is determined by the FRMPOL bit
- 0 = Slave select SPI support is disabled

bit 27 **FRMSYPW:** Frame Sync Pulse-Width bit
- 1 = Frame sync pulse is one character wide
- 0 = Frame sync pulse is one clock wide

bit 26-24 **FRMCNT<2:0>:** Frame Sync Pulse Counter bits

Controls the number of data characters transmitted per pulse. This bit is only valid in Framed mode.
- 111 = Reserved
- 110 = Reserved
- 101 = Generates a frame sync pulse on every 32 data characters
- 100 = Generates a frame sync pulse on every 16 data characters
- 011 = Generates a frame sync pulse on every 8 data characters
- 010 = Generates a frame sync pulse on every 4 data characters
- 001 = Generates a frame sync pulse on every 2 data characters
- 000 = Generates a frame sync pulse on every data character

Note 1: These bits can only be written when the ON bit = 0. Refer to **Section 26.0 "Electrical Characteristics"** for maximum clock frequency requirements.

2: This bit is not used in the Framed SPI mode. The user should program this bit to '0' for the Framed SPI mode (FRMEN = 1).

3: When AUDEN = 1, the SPI/I^2S module functions as if the CKP bit is equal to '1', regardless of the actual value of the CKP bit.

4: These bits are present for legacy compatibility and are superseded by PPS functionality on these devices (see **Section 9.8 "Peripheral Pin Select (PPS)"** for more information).

REGISTER 13-1: SPIxCON: SPIx CONTROL REGISTER (CONTINUED)

bit 7 **SSEN:** Slave Select Enable (Slave mode) bit
1 = $\overline{SSx}$ pin is used for Slave mode
0 = $\overline{SSx}$ pin is not used for Slave mode, pin is controlled by port function

bit 6 **CKP:** Clock Polarity Select bit(3)
1 = Idle state for clock is a high level; active state is a low level
0 = Idle state for clock is a low level; active state is a high level

bit 5 **MSTEN:** Master Mode Enable bit
1 = Master mode
0 = Slave mode

bit 4 **DISSDI:** Disable SDIx bit(4)
1 = SDIx pin is not used by the SPIx module (pin is controlled by port function)
0 = SDIx pin is controlled by the SPIx module

bit 3-2 **STXISEL<1:0>:** SPIx Transmit Buffer Empty Interrupt Mode bits
11 = Interrupt is generated when the buffer is not full (has one or more empty elements)
10 = Interrupt is generated when the buffer is empty by one-half or more
01 = Interrupt is generated when the buffer is completely empty
00 = Interrupt is generated when the last transfer is shifted out of SPIxSR and transmit operations are complete

bit 1-0 **SRXISEL<1:0>:** SPIx Receive Buffer Full Interrupt Mode bits
11 = Interrupt is generated when the buffer is full
10 = Interrupt is generated when the buffer is full by one-half or more
01 = Interrupt is generated when the buffer is not empty
00 = Interrupt is generated when the last word in the receive buffer is read (i.e., buffer is empty)

Note 1: These bits can only be written when the ON bit = 0. Refer to **Section 26.0 "Electrical Characteristics"** for maximum clock frequency requirements.

2: This bit is not used in the Framed SPI mode. The user should program this bit to '0' for the Framed SPI mode (FRMEN = 1).

3: When AUDEN = 1, the SPI/I^2S module functions as if the CKP bit is equal to '1', regardless of the actual value of the CKP bit.

4: These bits are present for legacy compatibility and are superseded by PPS functionality on these devices (see **Section 9.8 "Peripheral Pin Select (PPS)"** for more information).

REGISTER 13-2: SPIxCON2: SPIx CONTROL REGISTER 2

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	SPISGNEXT	—	—	FRMERREN	SPIROVEN	SPITUREN	IGNROV	IGNTUR
7:0	R/W-0	U-0	U-0	U-0	R/W-0	U-0	R/W-0	R/W-0
	AUDEN(1)	—	—	—	AUDMONO(1,2)	—	AUDMOD<1:0>(1,2)	

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 **Unimplemented:** Read as '0'

bit 15 **SPISGNEXT:** SPIx Sign-Extend Read Data from the RX FIFO bit
1 = Data from RX FIFO is sign-extended
0 = Data from RX FIFO is not sign-extended

bit 14-13 **Unimplemented:** Read as '0'

bit 12 **FRMERREN:** Enable Interrupt Events via FRMERR bit
1 = Frame error overflow generates error events
0 = Frame error does not generate error events

bit 11 **SPIROVEN:** Enable Interrupt Events via SPIROV bit
1 = Receive Overflow (ROV) generates error events
0 = Receive Overflow does not generate error events

bit 10 **SPITUREN:** Enable Interrupt Events via SPITUR bit
1 = Transmit Underrun (TUR) generates error events
0 = Transmit Underrun does not generate error events

bit 9 **IGNROV:** Ignore Receive Overflow (ROV) bit (for audio data transmissions)
1 = A ROV is not a critical error; during ROV, data in the FIFO is not overwritten by receive data
0 = A ROV is a critical error which stops SPIx operation

bit 8 **IGNTUR:** Ignore Transmit Underrun (TUR) bit (for audio data transmissions)
1 = A TUR is not a critical error and zeros are transmitted until the SPIxTXB is not empty
0 = A TUR is a critical error which stops SPIx operation

bit 7 **AUDEN:** Enable Audio Codec Support bit(1)
1 = Audio protocol is enabled
0 = Audio protocol is disabled

bit 6-4 **Unimplemented:** Read as '0'

bit 3 **AUDMONO:** Transmit Audio Data Format bit(1,2)
1 = Audio data is mono (each data word is transmitted on both left and right channels)
0 = Audio data is stereo

bit 2 **Unimplemented:** Read as '0'

bit 1-0 **AUDMOD<1:0>:** Audio Protocol Mode bits(1,2)
11 = PCM/DSP mode
10 = Right Justified mode
01 = Left Justified mode
00 = I^2S mode

Note 1: These bits can only be written when the ON bit = 0.
2: These bits are only valid for AUDEN = 1.

15.1 RTCC Control Registers

TABLE 15-1: RTCC REGISTER MAP

Virtual Address (BF80_#)	Register Name(1)	Bit Range	Bits																All Resets
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	
0000	RTCCON1	31:16	ALRMEN	CHIME	—	—	AMASK<3:0>				ALMRPT<7:0>								0000
		15:0	ON	—	—	—	WRLOCK	—	—	—	RTCOE	OUTSEL<2:0>			—	—	—	—	0000
0010	RTCCON2	31:16	DIV<15:0>																0000
		15:0	FDIV<4:0>					—	—	—	—	—	—	—	—	—	CLKSEL<1:0>		0000
0030	RTCSTAT	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	—	—	—	—	—	—	ALMEVT	—	—	SYNC	ALMSYNC	HALFSEC	0000
0040	RTCTIME	31:16	—	HRTEN<2:0>			HRONE<3:0>				—	MINTEN<2:0>			MINONE<3:0>				xxxx
		15:0	SECTEN<3:0>				SECONE<3:0>				—	—	—	—	—	—	—	—	xx00
0050	RTCDATE	31:16	YRTEN<3:0>				YRONE<3:0>				—	—	—	MTHTEN	MTHONE<3:0>				0000
		15:0	—	—	DAYTEN<1:0>		DAYONE<3:0>				—	—	—	—	—	WDAY<2:0>			0000
0060	ALMTIME	31:16	—	HRTEN<2:0>			HRONE<3:0>				—	MINTEN<2:0>			MINONE<3:0>				xxxx
		15:0	SECTEN<3:0>				SECONE<3:0>				—	—	—	—	—	—	—	—	xx00
0070	ALMDATE	31:16	—	—	—	—	—	—	—	—	—	—	—	MTHTEN	MTHONE<3:0>				0000
		15:0	—	—	DAYTEN<1:0>		DAYONE<3:0>				—	—	—	—	—	WDAY<2:0>			0000

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual address, plus an offset of 0x4, 0x8 and 0xC, respectively.

16.0 12-BIT ANALOG-TO-DIGITAL CONVERTER WITH THRESHOLD DETECT

Note: This data sheet summarizes the features of the PIC32MM0064GPL036 family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **Section 25. "12-Bit Analog-to-Digital Converter (ADC) with Threshold Detect"** (DS60001359) in the *"PIC32 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com/PIC32). The information in this data sheet supersedes the information in the FRM.

16.1 Introduction

The 12-bit ADC Converter with Threshold Detect includes the following features:

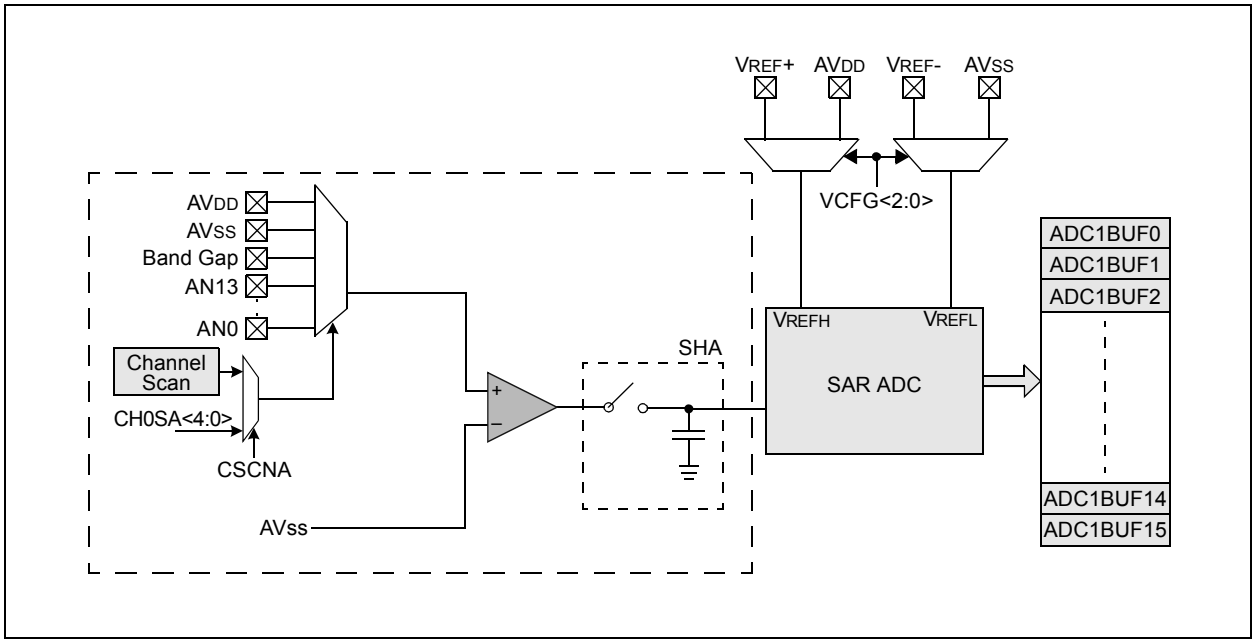
- Successive Approximation Register (SAR) Conversion
- User-Selectable Resolution of 10 or 12 Bits
- Conversion Speeds of up to 200 ksps for 12-bit mode and 300 ksps for 10-bit mode
- Up to 17 Analog Inputs (internal and external)
- External Voltage Reference Input Pins
- Unipolar Differential Sample-and-Hold Amplifier (SHA)
- Automated Threshold Scan and Compare Operation to Pre-Evaluate Conversion Results
- Selectable Conversion Trigger Source
- Fixed-Length Configurable Conversion Result Buffer
- Eight Options for Result Alignment and Encoding
- Configurable Interrupt Generation
- Operation during CPU Sleep and Idle modes

Figure 16-1 illustrates a block diagram of the 12-bit ADC. The 12-bit ADC has 14 external analog inputs, AN0 through AN13, and 3 internal analog inputs connected to VDD, VSS and band gap. In addition, there are two analog input pins for external voltage reference connections.

The analog inputs are connected through a multiplexer to the SHA. Unipolar differential conversions are possible on all inputs (see Figure 16-1).

The Automatic Input Scan mode sequentially converts multiple analog inputs. A special control register specifies which inputs will be included in the scanning sequence. The 12-bit ADC is connected to a 16-word result buffer. The 12-bit result is converted to one of eight output formats in either 32-bit or 16-bit word widths.

FIGURE 16-1: ADC BLOCK DIAGRAM



18.1 Control Registers

The CLCx module is controlled by the following registers:

- CLCxCON
- CLCxSEL
- CLCxGLS

The CLCx Control register (CLCxCON) is used to enable the module and interrupts, control the output enable bit, select output polarity and select the logic function. The CLCx Control registers also allow the user to control the logic polarity of not only the cell output, but also some intermediate variables.

The CLCx Input MUX Select register (CLCxSEL) allows the user to select up to 4 data input sources using the 4 data input selection multiplexers. Each multiplexer has a list of 8 data sources available.

The CLCx Gate Logic Input Select register (CLCxGLS) allows the user to select which outputs from each of the selection MUXes are used as inputs to the input gates of the logic cell. Each data source MUX outputs both a true and a negated version of its output. All of these 8 signals are enabled, ORed together by the logic cell input gates.

REGISTER 18-2: CLCxSEL: CLCx INPUT MUX SELECT REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	U-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0
	—	DS4<2:0>			—	DS3<2:0>		
7:0	U-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0
	—	DS2<2:0>			—	DS1<2:0>		

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-15 **Unimplemented:** Read as '0'

bit 14-12 **DS4<2:0>:** Data Selection MUX 4 Signal Selection bits

For CLC1:
111 = SCCP3 compare match event
110 = MCCP1 compare match event
101 = RTCC event
100 = Reserved
011 = SPI1 SDI input
010 = SCCP3 OCM3 output
001 = CLC2 output
000 = CLCINB I/O pin

For CLC2:
111 = SCCP3 compare match event
110 = MCCP1 compare match event
101 = RTCC event
100 = Reserved
011 = SPI2 SDI input
010 = SCCP3 OCM3 output
001 = CLC1 output
000 = CLCINB I/O pin

bit 11 **Unimplemented:** Read as '0'

REGISTER 23-10: ANCFG: BAND GAP CONTROL REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
7:0	U-0	U-0	U-0	U-0	U-0	R/W-0, HS, HC	R/W-0, HS, HC	U-0
	—	—	—	—	—	VBGADC	VBGCMP	—

Legend:	HC = Hardware Clearable bit	HS = Hardware Settable bit	
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-3 **Unimplemented:** Read as '0'

bit 2 **VBGADC:** ADC Band Gap Enable bit
1 = ADC band gap is enabled
0 = ADC band gap is disabled

bit 1 **VBGCMP:** Comparator Band Gap Enable bit
1 = Comparator band gap is enabled
0 = Comparator band gap is disabled

bit 0 **Unimplemented:** Read as '0'

24.2 MPLAB XC Compilers

The MPLAB XC Compilers are complete ANSI C compilers for all of Microchip's 8, 16 and 32-bit MCU and DSC devices. These compilers provide powerful integration capabilities, superior code optimization and ease of use. MPLAB XC Compilers run on Windows, Linux or MAC OS X.

For easy source level debugging, the compilers provide debug information that is optimized to the MPLAB X IDE.

The free MPLAB XC Compiler editions support all devices and commands, with no time or memory restrictions, and offer sufficient code optimization for most applications.

MPLAB XC Compilers include an assembler, linker and utilities. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. MPLAB XC Compiler uses the assembler to produce its object file. Notable features of the assembler include:

- Support for the entire device instruction set
- Support for fixed-point and floating-point data
- Command-line interface
- Rich directive set
- Flexible macro language
- MPLAB X IDE compatibility

24.3 MPASM Assembler

The MPASM Assembler is a full-featured, universal macro assembler for PIC10/12/16/18 MCUs.

The MPASM Assembler generates relocatable object files for the MPLINK Object Linker, Intel® standard HEX files, MAP files to detail memory usage and symbol reference, absolute LST files that contain source lines and generated machine code, and COFF files for debugging.

The MPASM Assembler features include:

- Integration into MPLAB X IDE projects
- User-defined macros to streamline assembly code
- Conditional assembly for multipurpose source files
- Directives that allow complete control over the assembly process

24.4 MPLINK Object Linker/ MPLIB Object Librarian

The MPLINK Object Linker combines relocatable objects created by the MPASM Assembler. It can link relocatable objects from precompiled libraries, using directives from a linker script.

The MPLIB Object Librarian manages the creation and modification of library files of precompiled code. When a routine from a library is called from a source file, only the modules that contain that routine will be linked in with the application. This allows large libraries to be used efficiently in many different applications.

The object linker/library features include:

- Efficient linking of single libraries instead of many smaller files
- Enhanced code maintainability by grouping related modules together
- Flexible creation of libraries with easy module listing, replacement, deletion and extraction

24.5 MPLAB Assembler, Linker and Librarian for Various Device Families

MPLAB Assembler produces relocatable machine code from symbolic assembly language for PIC24, PIC32 and dsPIC DSC devices. MPLAB XC Compiler uses the assembler to produce its object file. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. Notable features of the assembler include:

- Support for the entire device instruction set
- Support for fixed-point and floating-point data
- Command-line interface
- Rich directive set
- Flexible macro language
- MPLAB X IDE compatibility

TABLE 26-14: COMPARATOR SPECIFICATIONS

Operating Conditions: 2.0V < VDD < 3.6V, -40°C < TA < +85°C (unless otherwise stated)						
Param No.	**Symbol**	**Characteristic**	**Min**	**Typ(2)**	**Max**	**Units**
D300	VIOFF	Input Offset Voltage	-20	—	20	mV
D301	VICM	Input Common-Mode Voltage	AVSS – 0.3V	—	AVDD + 0.3V	V
D307	TRESP(1)	Response Time	—	150	—	ns

Note 1: Measured with one input at VDD/2 and the other transitioning from VSS to VDD.

2: Data in the "Typ" column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

TABLE 26-15: VOLTAGE REFERENCE SPECIFICATIONS

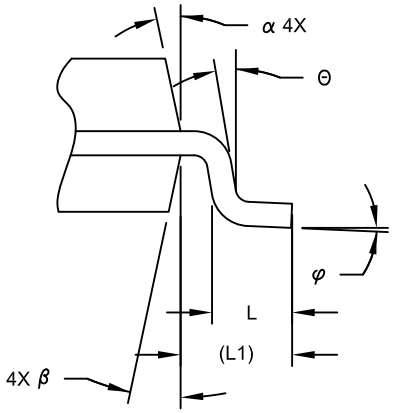
Operating Conditions: 2.0V < VDD < 3.6V, -40°C < TA < +85°C (unless otherwise stated)						
Param No.	**Symbol**	**Characteristic**	**Min**	**Typ(2)**	**Max**	**Units**
VRD310	TSET	Settling Time(1)	—	—	10	µs
VRD311	VRA	Accuracy	-1	—	1	LSb
VRD312	VRUR	Unit Resistor Value (R)	—	4.5	—	kΩ

Note 1: Measures the interval while VRDAT<4:0> transitions from '11111' to '00000'.

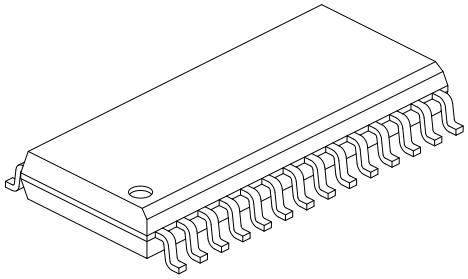
2: Data in the "Typ" column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



VIEW C



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		28	
Pitch	e		1.27 BSC	
Overall Height	A	-	-	2.65
Molded Package Thickness	A2	2.05	-	-
Standoff §	A1	0.10	-	0.30
Overall Width	E		10.30 BSC	
Molded Package Width	E1		7.50 BSC	
Overall Length	D		17.90 BSC	
Chamfer (Optional)	h	0.25	-	0.75
Foot Length	L	0.40	-	1.27
Footprint	L1		1.40 REF	
Lead Angle	Θ	0°	-	-
Foot Angle	φ	0°	-	8°
Lead Thickness	c	0.18	-	0.33
Lead Width	b	0.31	-	0.51
Mold Draft Angle Top	α	5°	-	15°
Mold Draft Angle Bottom	β	5°	-	15°

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. § Significant Characteristic
3. Dimension D does not include mold flash, protrusions or gate burrs, which shall not exceed 0.15 mm per end. Dimension E1 does not include interlead flash or protrusion, which shall not exceed 0.25 mm per side.
4. Dimensioning and tolerancing per ASME Y14.5M

   BSC: Basic Dimension. Theoretically exact value shown without tolerances.

   REF: Reference Dimension, usually without tolerance, for information purposes only.
5. Datums A & B to be determined at Datum H.

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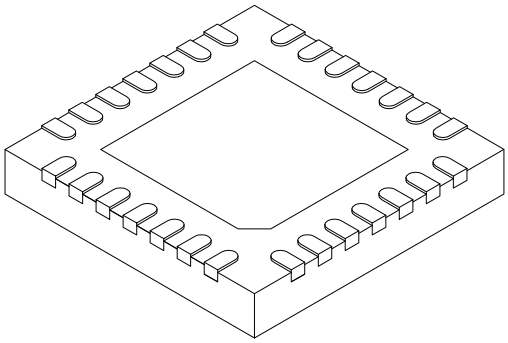
28-Lead Plastic Quad Flat, No Lead Package (ML) - 6x6 mm Body [QFN] With 0.55 mm Terminal Length

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	MILLIMETERS		
Dimension	Limits	MIN	NOM	MAX
Number of Pins	N		28	
Pitch	e		0.65 BSC	
Overall Height	A	0.80	0.90	1.00
Standoff	A1	0.00	0.02	0.05
Terminal Thickness	A3		0.20 REF	
Overall Width	E		6.00 BSC	
Exposed Pad Width	E2	3.65	3.70	4.20
Overall Length	D		6.00 BSC	
Exposed Pad Length	D2	3.65	3.70	4.20
Terminal Width	b	0.23	0.30	0.35
Terminal Length	L	0.50	0.55	0.70
Terminal-to-Exposed Pad	K	0.20	-	-

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is saw singulated
3. Dimensioning and tolerancing per ASME Y14.5M.

   BSC: Basic Dimension. Theoretically exact value shown without tolerances.

   REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-105C Sheet 2 of 2

APPENDIX A: REVISION HISTORY

Revision A (February 2015)

This is the initial version of the document.

Revision B (May 2016)

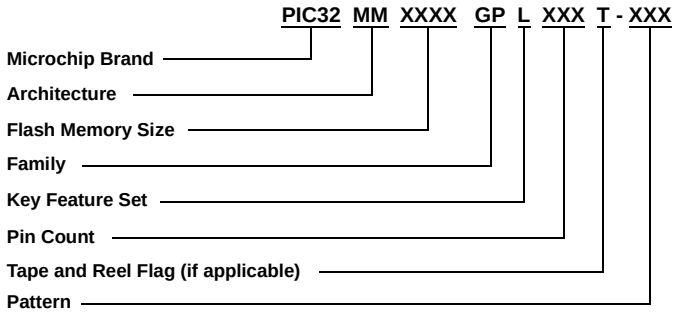
This revision incorporates the following updates:

- Registers:
  - Updates Register 5-1, Register 5-3, Register 5-6, Register 5-7, Register 6-3, Register 6-4, Register 7-2, Register 8-2, Register 8-3, Register 8-5, Register 8-6, Register 11-1, Register 13-1, Register 14-1, Register 15-1, Register 15-5, Register 15-6, Register 16-1, Register 16-2, Register 16-3, Register 16-5, Register 18-2, Register 19-1, Register 19-2 and Register 23-7
- Tables:
  - Updates Table 1-1, Table 5-1, Table 6-1,Table 7-2, Table 7-3, Table 9-3, Table 9-7, Table 15-1, Table 16-1, Table 19-1, Table 22-1, Table 23-4, Table 23-5 Table 26-2, Table 26-3, Table 26-4 and Table 26-6 through Table 26-33
  - Adds Table 23-8
- Figures:
  - Updates Figure 1-1, Figure 3-1, Figure 8-1, Figure 10-1, Figure 14-1, Figure 13-1, Figure 14-1, Figure 14-1, Figure 15-1, Figure 17-1, Figure 18-1, Figure 18-3, Figure 26-1, Figure 26-3, Figure 26-4, Figure 26-9, Figure 26-10, Figure 26-11 and Figure 26-12
- Updates pin function descriptions in **Section 1.0 “Device Overview”**
- Updates text in **Section 9.6 “Input Change Notification (ICN)”**, **Section 9.8.4 “Input Mapping”**, **Section 23.7 “Unique Device Identifier (UDID)”**, **Section 22.5 “Low-Power Brown-out Reset”** and **Section 27.0 “Packaging Information”**
- Adds **Section 5.1 “Flash Controller Registers Write Protection”**, **Section 8.0 “Oscillator Configuration”**, **Section 23.4 “System Registers Write Protection”**, reference to **Section 22.1 “Sleep Mode”**, **Section 22.2 “Idle Mode”** and **Section 23.8 “Reserved Registers”**
- Updates the Absolute Maximum Ratings in **Section 26.0 “Electrical Characteristics”**

This revision also includes minor typographical and formatting changes throughout the data sheet text.

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.



Architecture	MM	= MIPS32® microAptiv™ UC CPU Core
Flash Memory Size	0016 0032 0064	= 16 Kbytes = 32 Kbytes = 64 Kbytes
Family	GP	= General Purpose Family
Key Feature	L	= Up to 25 MHz operating frequency with basic peripheral set of 2 UART and 2 SPI modules
Pin Count	020 028 036	= 20-pin = 28-pin = 36/40-pin
Pattern	Three-digit QTP, SQTP, Code or Special Requirements (blank otherwise) ES	= Engineering Sample

Example:

PIC32MM0064GPL036-I/M2: PIC32 General Purpose Device with MIPS32® microAptiv™ UC Core, 64-Kbyte Program Memory, 36-Pin Package.

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